

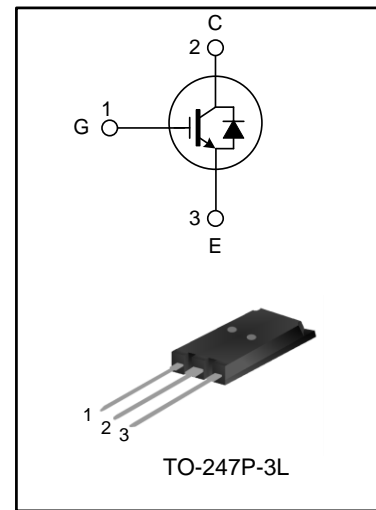
## 75A, 1200V FIELD STOP IGBT

### DESCRIPTION

The SGTP75V120FDB2PW field stop IGBT adopts Silan Field Stop V technology, features low conduction loss and switching loss. This device is applicable to photovoltaic, UPS, SMPS, and PFC fields.

### FEATURES

- ◆ 75A, 1200V,  $V_{CE(sat)}(typ.)=1.9V@I_C=75A$
- ◆ Low conduction loss
- ◆ Ultra-fast switching
- ◆ High input impedance
- ◆  $T_{Jmax}=175^{\circ}C$



### NOMENCLATURE

SGT P 75 V 120 F D B 2 PW		
IGBT series		Package
Industrial grade		PW: TO-247P-3L
Current, 75: 750A		1,2,3... : Version No.
N : N-channel		Blank: Standard diode
NE : N-channel planner gate with ESD		M : Standard diode, full range
T : Field Stop 3/4		R : Rapid diode
U : Field Stop 4+		B : Rapid diode, full range
V : Field Stop 5		S : Ultra soft diode, full range
W : Field Stop 5+		D : packaged with fast recovery diode
Y : Field Stop5++		R : RC IGBT
A : Field Stop 6		Blank: single IGBT
Voltage, 75:750V		C : Sic
120: 1200V		L : Ultra low switching, recommended frequency ~2KHz
		Q : Low switching, recommended frequency 2~20KHz
		S : Standard frequency, recommended frequency 5~40KHz
		F : Fast switching, recommended frequency 10~60KHz
		UF : Ultra fast switching, recommended frequency 40KHz~
		I: Igniter

### ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SGTP75V120FDB2PW	TO-247P-3L	P75V120FDB2	Halogen free	Tube

**ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED,  $T_C=25^{\circ}\text{C}$ )**

Characteristics		Symbol	Ratings	Unit
Collector - Emitter Voltage		$V_{CE}$	1200	V
Gate - Emitter Voltage		$V_{GE}$	$\pm 20$	V
Transient Gate - Emitter Voltage ( $t_p \leq 10\mu\text{s}$ , $D < 0.010$ )		$V_{GE}$	$\pm 30$	V
Collector Current	$T_C=25^{\circ}\text{C}$	$I_C$	150	A
	$T_C=100^{\circ}\text{C}$		75	
Pulsed Collector Current		$I_{CM}$	300	A
Diode Current	$T_C=25^{\circ}\text{C}$	$I_F$	150	A
	$T_C=100^{\circ}\text{C}$		75	A
Diode Pulsed Current		$I_{FM}$	300	A
Power Dissipation ( $T_C=25^{\circ}\text{C}$ )		$P_D$	833	W
Operating Junction Temperature		$T_J$	$-40 \sim +175$	$^{\circ}\text{C}$
Storage Temperature Range		$T_{stg}$	$-55 \sim +150$	$^{\circ}\text{C}$

**THERMAL CHARACTERISTICS**

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Thermal Resistance, Junction to Case (IGBT)	$R_{th(j-c)}$	--	--	--	0.18	$^{\circ}\text{C/W}$
Thermal Resistance, Junction to Case (FRD)	$R_{th(j-c)}$	--	--	--	0.40	$^{\circ}\text{C/W}$
Thermal Resistance, Junction to Ambient (IGBT)	$R_{th(j-a)}$	--	--	--	40	$^{\circ}\text{C/W}$
Soldering temperature (in line)	$T_{sld}$	$15^{+2}_{-0}$ sec, 1time	--	--	260	$^{\circ}\text{C}$

**ELECTRICAL CHARACTERISTICS OF IGBT (UNLESS OTHERWISE NOTED,  $T_J=25^{\circ}\text{C}$ )**

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Collector-emitter Breakdown Voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_C=250\mu A$	1200	--	--	V
Zero Gate Voltage Collector Current	$I_{CES}$	$V_{CE}=1200V, V_{GE}=0V$	--	--	400	$\mu A$
Gate-emitter Leakage Current	$I_{GES}$	$V_{GE}=20V, V_{CE}=0V$	--	--	$\pm 600$	nA
Gate-emitter Threshold Voltage	$V_{GE(th)}$	$I_C=250\mu A, V_{CE}=V_{GE}$	4.3	5.3	6.4	V
Collector-emitter Saturation Voltage	$V_{CEsat}$	$I_C=75A, V_{GE}=15V, T_J=25^{\circ}\text{C}$	--	1.9	2.5	V
		$I_C=75A, V_{GE}=15V, T_J=150^{\circ}\text{C}$	--	2.5	--	V
Input Capacitance	$C_{ies}$	$V_{CE}=30V$ $V_{GE}=0V$ $f=1\text{MHz}$	--	7300	--	pF
Output Capacitance	$C_{oes}$		--	175	--	
Reverse Transfer Capacitance	$C_{res}$		--	23	--	
Turn-On Delay Time	$T_{d(on)}$	$V_{CE}=600V$ $I_C=75A$ $R_g=10\Omega$ $V_{GE}=15V$ inductive load $T_J=25^{\circ}\text{C}$	--	68	--	ns
Rise Time	$T_r$		--	38	--	
Turn-Off Delay Time	$T_{d(off)}$		--	209	--	
Fall Time	$T_f$		--	37	--	
Turn-on Energy	$E_{on}$		--	5.80	--	mJ
Turn-off Energy	$E_{off}$		--	2.40	--	
Total Switching Energy	$E_{st}$		--	8.20	--	
Turn-On Delay Time	$T_{d(on)}$	$V_{CE}=600V$ $I_C=37.5A$ $R_g=10\Omega$ $V_{GE}=15V$ inductive load $T_J=25^{\circ}\text{C}$	--	66	--	ns
Rise Time	$T_r$		--	22	--	
Turn-Off Delay Time	$T_{d(off)}$		--	220	--	
Fall Time	$T_f$		--	29	--	
Turn-on Energy	$E_{on}$		--	1.88	--	mJ
Turn-off Energy	$E_{off}$		--	1.15	--	
Total Switching Energy	$E_{st}$		--	3.03	--	
Total Gate Charge	$Q_g$	$V_{CE}=600V, I_C=75A, V_{GE}=15V$	--	234	--	nC
Gate to Emitter Charge	$Q_{ge}$		--	67	--	
Gate to Collector Charge	$Q_{gc}$		--	68	--	

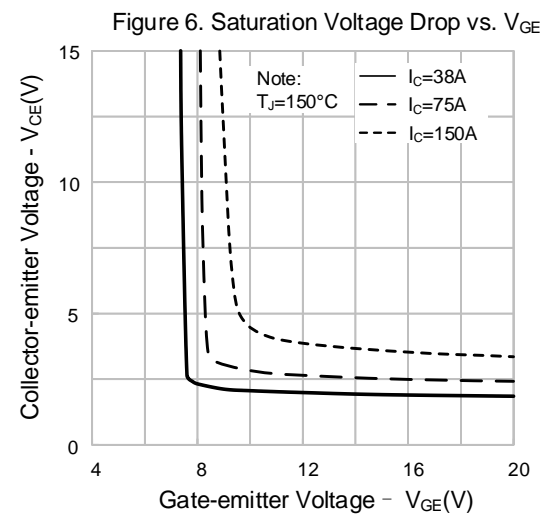
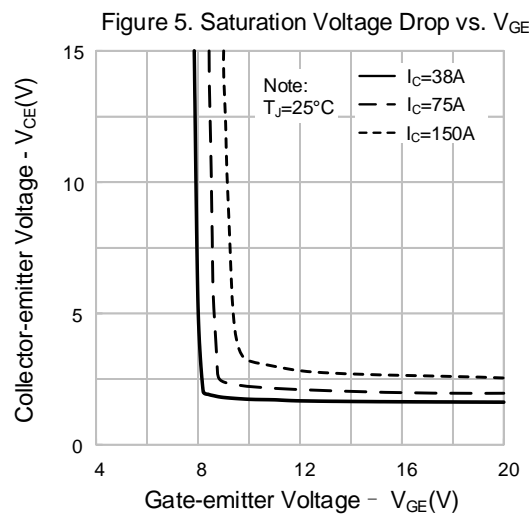
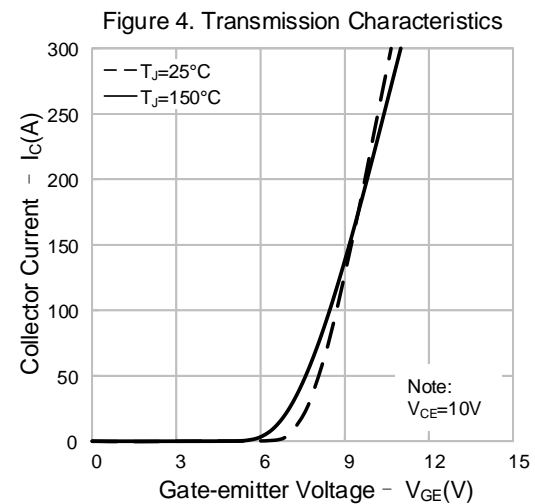
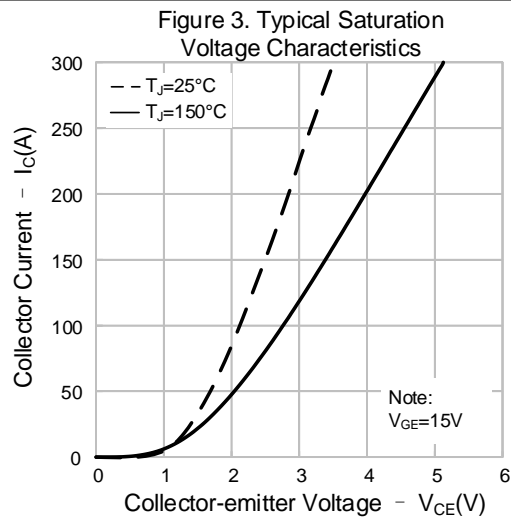
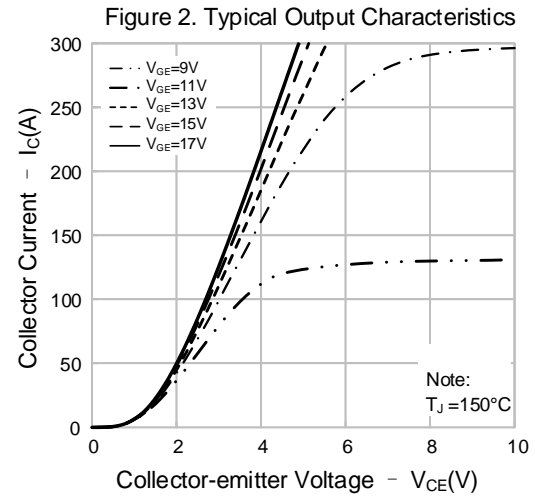
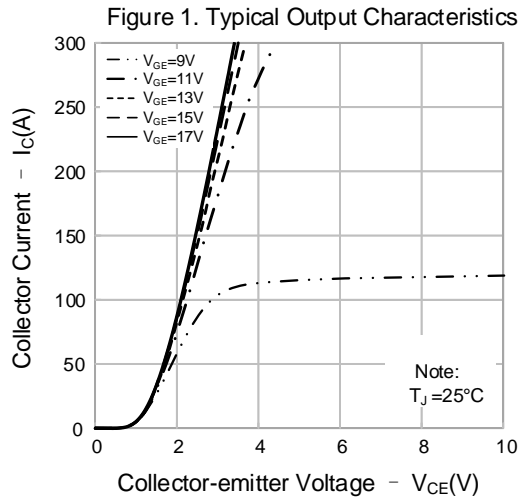
## ELECTRICAL CHARACTERISTICS OF FRD (UNLESS OTHERWISE NOTED, $T_J=25^{\circ}\text{C}$ )

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Diode Forward Voltage	$V_F$	$I_F=75\text{A}$ , $T_J=25^{\circ}\text{C}$	--	3.0	3.8	V
		$I_F=75\text{A}$ , $T_J=150^{\circ}\text{C}$	--	2.6	--	
Diode Reverse Recovery Time	$T_{rr}$	$I_{ES}=75\text{A}$ , $dI_{ES}/dt=200\text{A}/\mu\text{s}$ , $T_J=25^{\circ}\text{C}$	--	63	--	ns
Diode Reverse Recovery Charge	$Q_{rr}$		--	260	--	nC
Diode Reverse Recovery Current	$I_{rrm}$		--	7.6	--	A

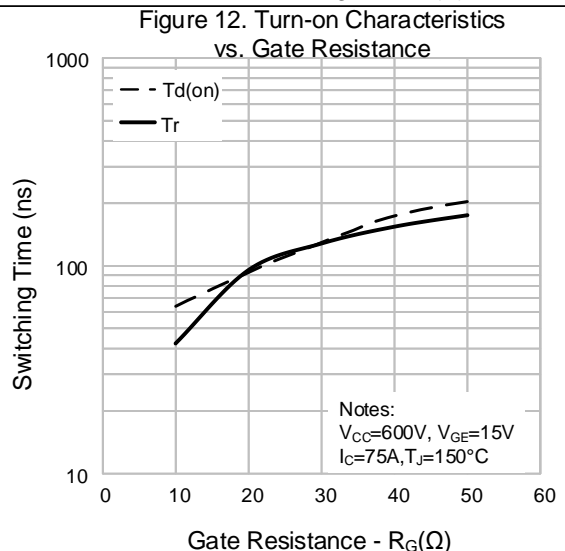
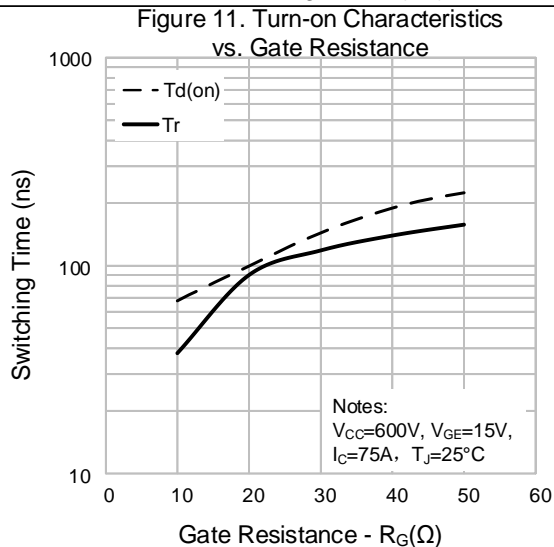
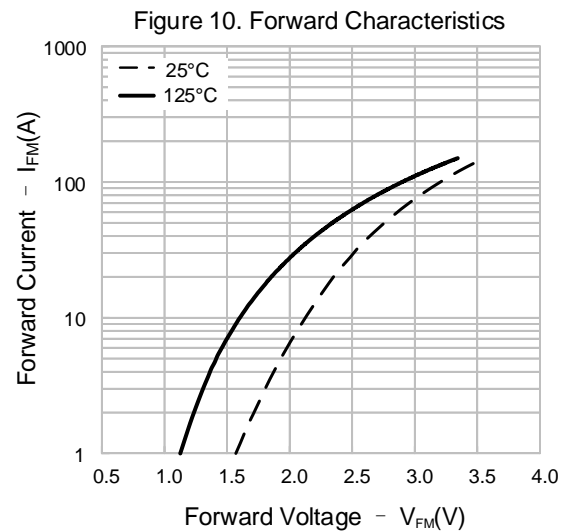
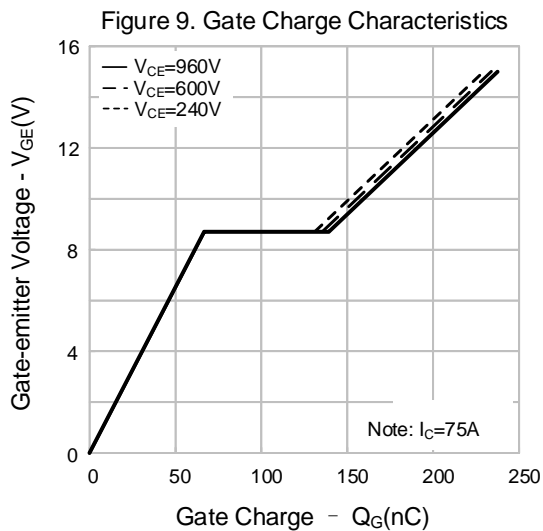
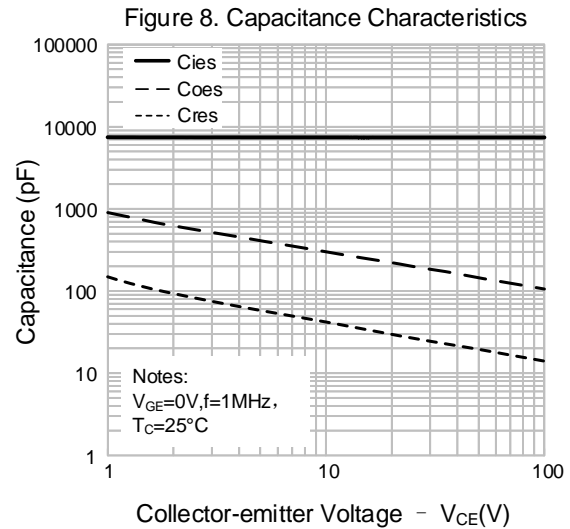
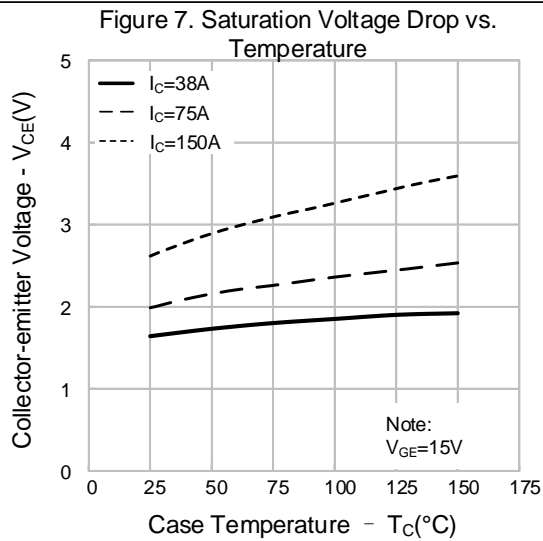
## ELECTRICAL CHARACTERISTICS OF IGBT (UNLESS OTHERWISE NOTED, $T_J=150^{\circ}\text{C}$ )

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Turn-On Delay Time	$T_{d(on)}$	$V_{CE}=600\text{V}$ $I_C=75\text{A}$ $R_g=10\Omega$ $V_{GE}=15\text{V}$ Inductive load $T_J=150^{\circ}\text{C}$	--	64	--	ns
Rise Time	$T_r$		--	42	--	
Turn-Off Delay Time	$T_{d(off)}$		--	260	--	
Fall Time	$T_f$		--	89	--	
Turn-on Energy	$E_{on}$	$V_{CE}=600\text{V}$ $I_C=37.5\text{A}$ $R_g=10\Omega$ $V_{GE}=15\text{V}$ Inductive load $T_J=150^{\circ}\text{C}$	--	5.98	--	mJ
Turn-off Energy	$E_{off}$		--	3.84	--	
Total Switching Energy	$E_{st}$		--	9.82	--	
Turn-On Delay Time	$T_{d(on)}$		--	60	--	ns
Rise Time	$T_r$		--	25	--	
Turn-Off Delay Time	$T_{d(off)}$		--	294	--	
Fall Time	$T_f$		--	69	--	
Turn-on Energy	$E_{on}$	$V_{CE}=600\text{V}$ $I_C=37.5\text{A}$ $R_g=10\Omega$ $V_{GE}=15\text{V}$ Inductive load $T_J=150^{\circ}\text{C}$	--	2.04	--	mJ
Turn-off Energy	$E_{off}$		--	1.84	--	
Total Switching Energy	$E_{st}$		--	3.88	--	

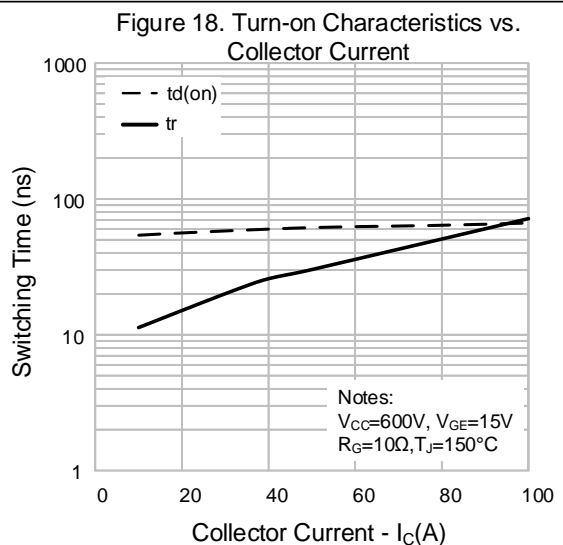
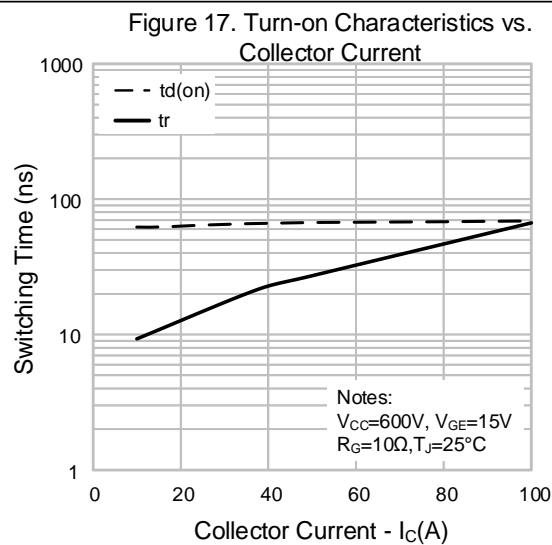
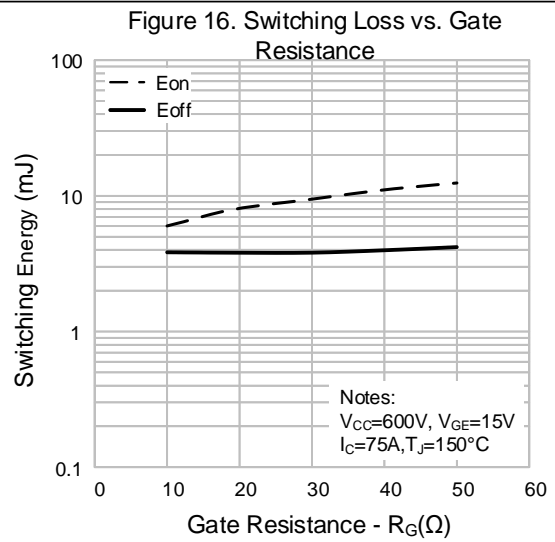
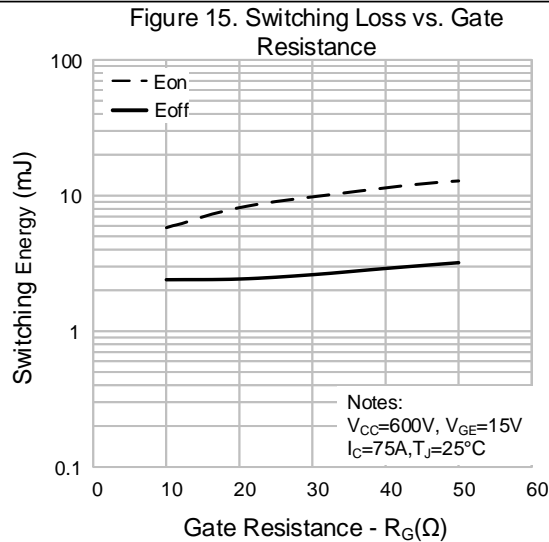
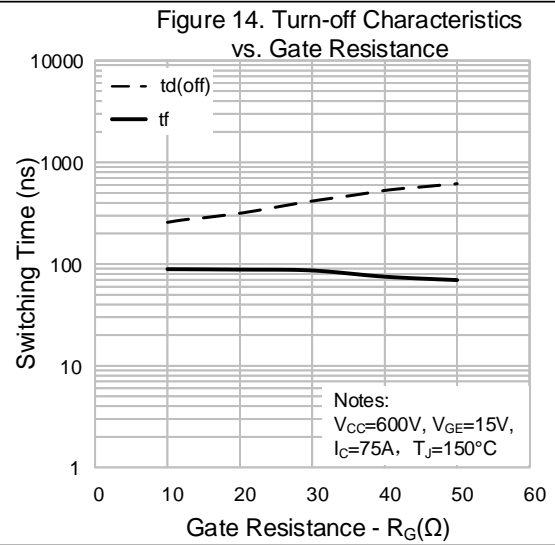
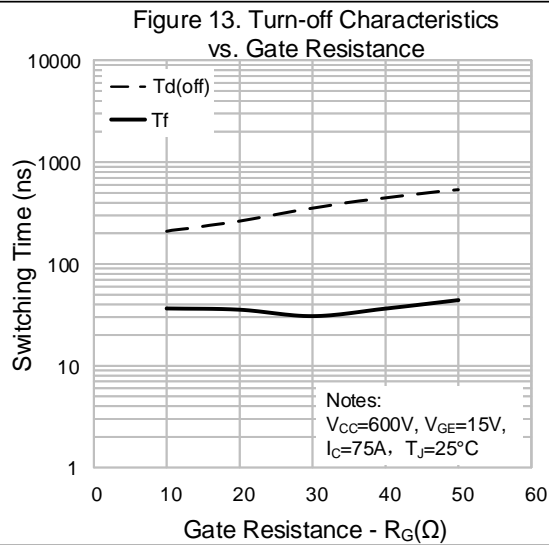
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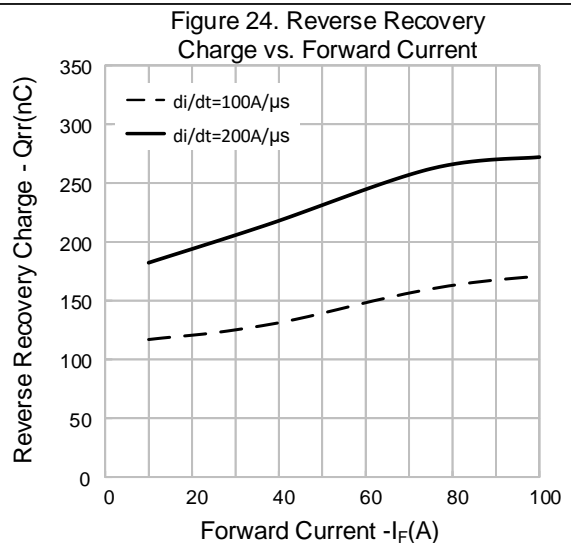
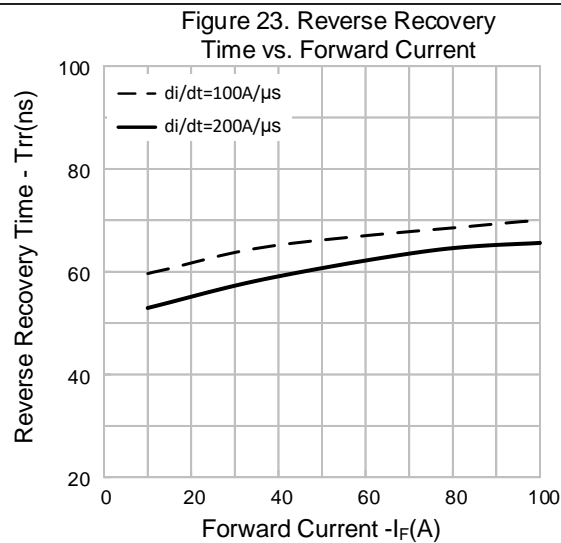
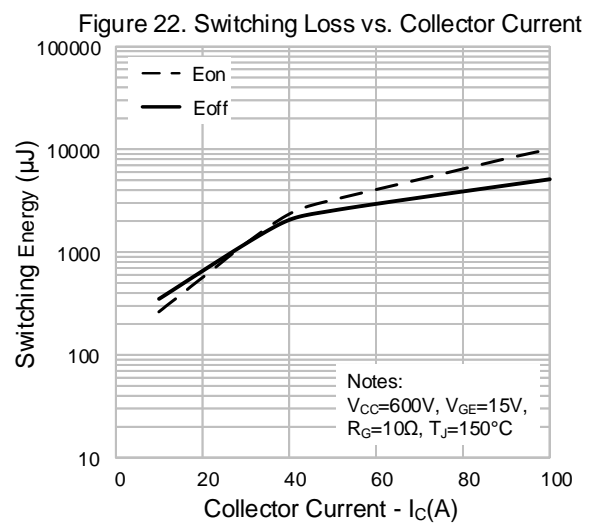
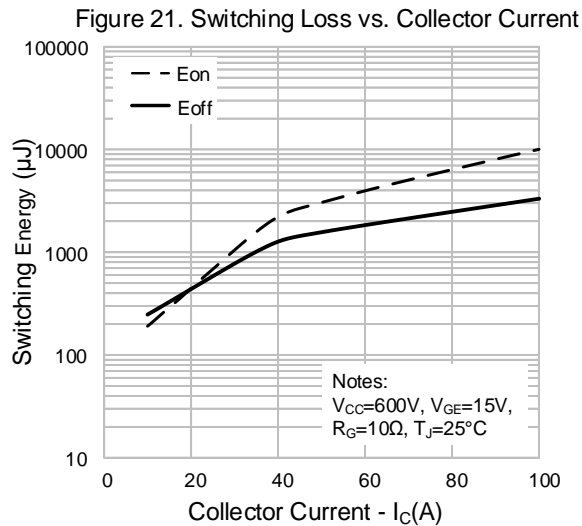
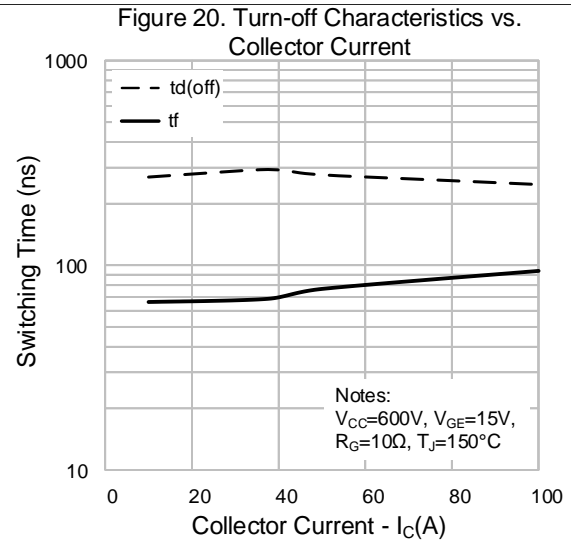
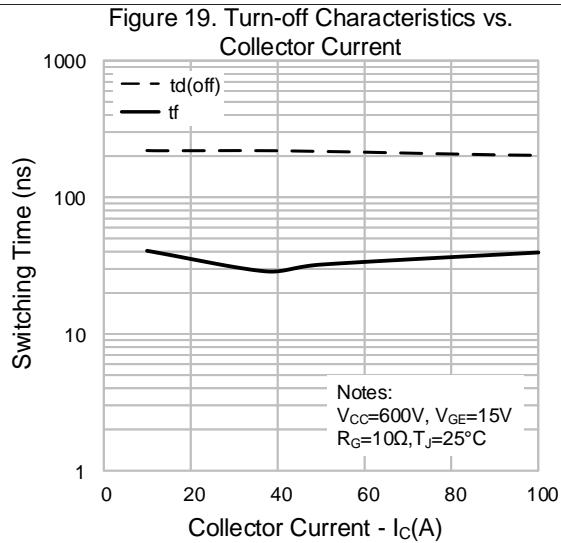
**TYPICAL CHARACTERISTICS (CONTINUED)**



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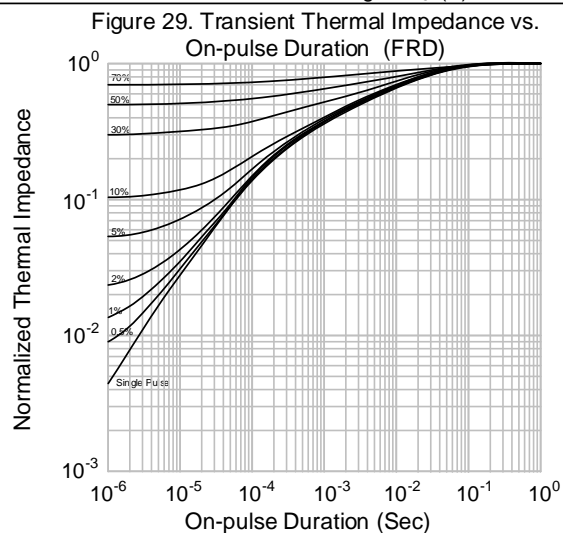
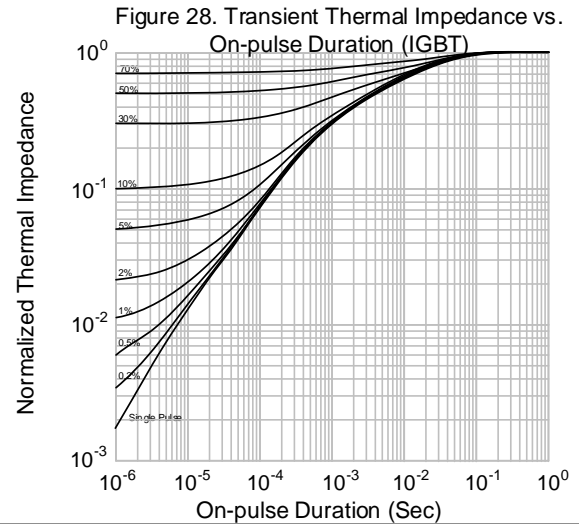
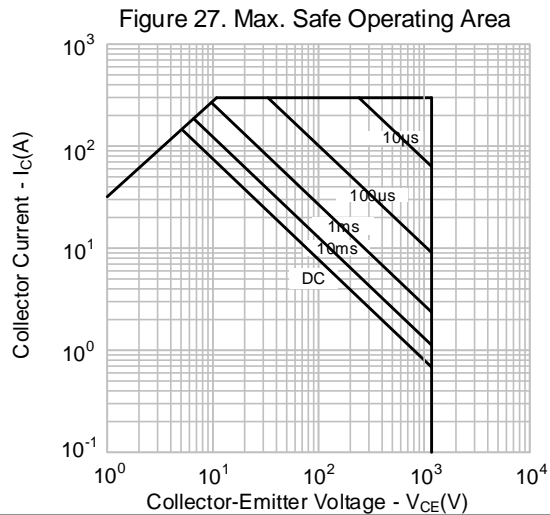
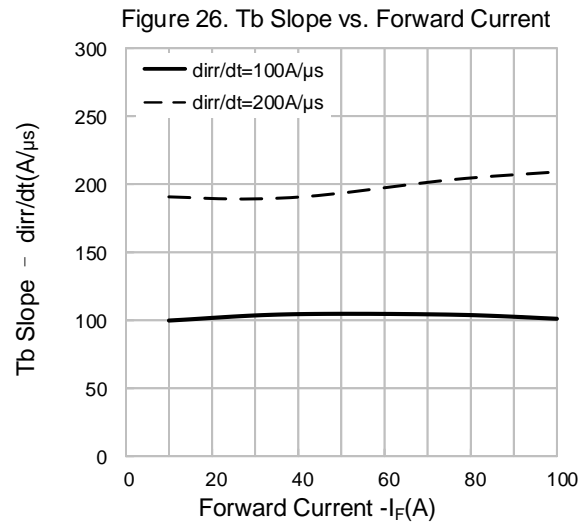
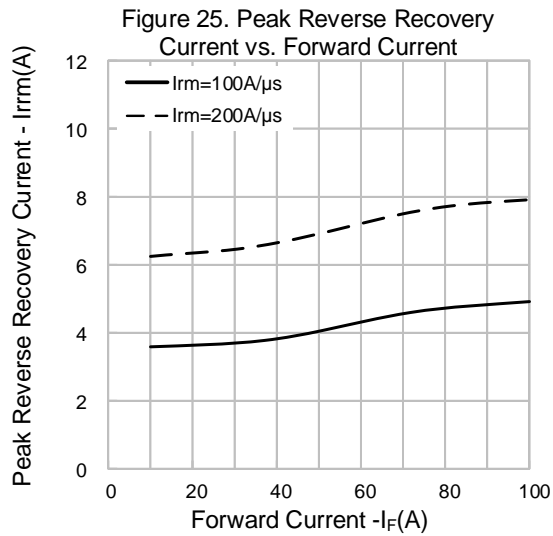


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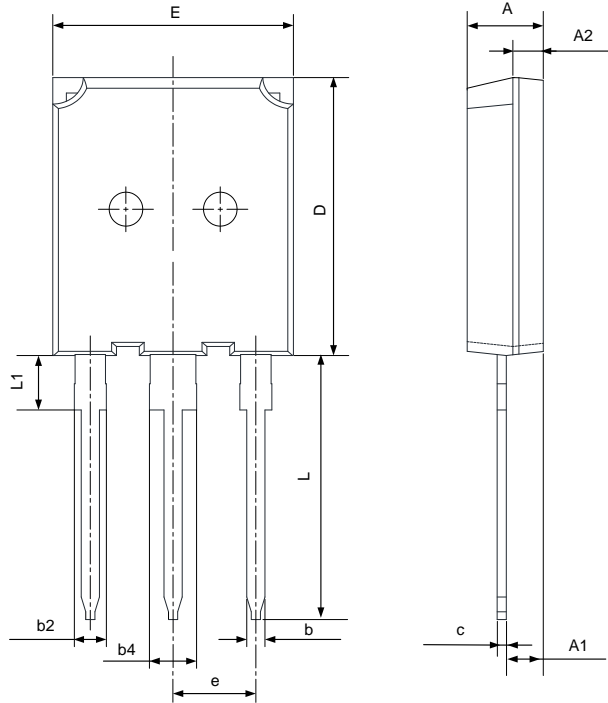
**TYPICAL CHARACTERISTICS (CONTINUED)**



## PACKAGE OUTLINE

TO-247P-3L

UNIT: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16	—	1.26
b2	—	—	2.25
b4	—	—	3.25
c	0.59	—	0.66
D	20.90	21.00	21.10
E	15.70	15.80	15.90
e	5.436 BSC		
L	19.80	19.95	20.10
L1	—	—	4.30



### IGBT DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the IGBT electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- IGBT devices should be packed in antistatic/conductive containers for transportation.

**Important notice :**

1. Silan reserves the right to make changes of this instruction without notice.
2. Customers should obtain the latest relevant information when purchasing and should verify whether such information is latest and complete. Please read this instruction and application manual and related materials carefully before using products, including the circuit operation precautions, etc.
3. It is neither tested nor verified in accordance with AEC-Q series standards testing or application requirements. Silan does not give any warranties as to the suitability of the Silan's product for any specific use. The design intent, design definition and design of the product are not intended for application (the application stated in this instruction includes use, etc.) in transportation equipment, medical equipment, life-saving equipment, aerospace equipment, non-civil equipment or non-civil use, etc. (the equipment stated in this instruction includes systems, devices, etc., all referred to as equipment). The product should not be used in any equipment or system whose manufacture, use or sale is prohibited under any applicable laws or regulations ("unintended use"). If the product is used for unintended use, therefore the full risks of such products application are borne by the customer and Silan assumes no liability for the product used for the unintended use. If the customer intends to use the Silan's product in a application where malfunction or failure can be reasonably be expected to result in personal injury, or serious property, or environment damage, the customer shall make adequate assessment, testing and verification, and Silan shall not be liable for such applications.
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5. Do not disassemble, reverse-engineer, alter, modify, decompile or copy product, without Silan's prior written consent.
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7. Please use and apply product in compliance with all applicable laws and regulations, including but not limited to trade control regulations etc. The product is civil electronic product, please do not use it in non-civil fields.
8. Product promotion is endless, our company will wholeheartedly provide customers with better products!
9. Website: <http://www.silan.com.cn>

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Rev.: 1.1

Revision History:

1. Update nomenclature and parameter name
  2. Update important notice
- 

Rev.: 1.0

Revision History:

1. First release
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